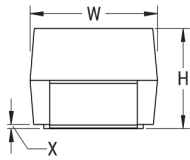


T541X337M016AH6720

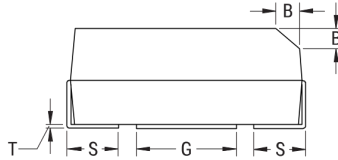
Aliases (DLA Drawing 04052-056B)

T541 HRA, Tantalum, Polymer Tantalum, HRA Multi-Anode, 330 uF, 20%, 16 VDC, SMD, Polymer, Molded, High Reliability, Multi-Anode, Low ESR, N/A, 25 mOhms, 7343, Height Max = 4.3mm

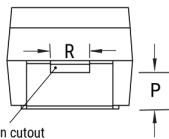
CATHODE (-) END VIEW



SIDE VIEW



ANODE (+) END VIEW



BOTTOM VIEW



Click [here](#) for the 3D model.

General Information

| | |
|------------------|--|
| Series | T541 HRA |
| Dielectric | Polymer Tantalum |
| Style | SMD Chip |
| Description | SMD, Polymer, Molded, High Reliability, Multi-Anode, Low ESR |
| Features | Non-Combustible, Multiple Anode, Low ESR, High Reliability |
| RoHS | No |
| Prop 65 | ⚠ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov . |
| SCIP Number | b064b03e-bd75-42af-b342-1fe94dec2340 |
| Termination | Solder Coated |
| Qualifications | DLA Drawing 04052 |
| AEC-Q200 | No |
| Component Weight | 410.89 mg |
| Shelf Life | 52 Weeks |
| MSL | 3 |

Specifications

| | |
|-------------------------|--|
| Capacitance | 330 uF |
| Capacitance Tolerance | 20% |
| Voltage DC | 16 VDC (105C), 10.72 VDC (125C) |
| Temperature Range | -55/+125°C |
| Rated Temperature | 105°C |
| Humidity | 60C, 90% RH, 500 Hours, rated voltage |
| Dissipation Factor | 10% 120Hz 25C |
| Failure Rate | N/A |
| Resistance | 25 mOhms (100kHz 25C) |
| Ripple Current | 3286 mA (rms, 100kHz 45C) |
| Leakage Current | 528 uA (5min 25°C) |
| Testing and Reliability | 10 Cycles Surge Current Testing At -55C +0C/-5C And +85C +/-5C After Voltage Aging |

Dimensions

| | |
|-----------|-----------------|
| Footprint | 7343 |
| L | 7.3mm +/-0.3mm |
| W | 4.3mm +/-0.3mm |
| H | 4mm +/-0.3mm |
| T | 0.13mm REF |
| S | 1.3mm +/-0.3mm |
| F | 2.4mm +/-0.1mm |
| A | 3.8mm MIN |
| B | 0.5mm +/-0.15mm |
| E | 3.5mm REF |
| G | 3.5mm REF |
| P | 1.7mm REF |
| R | 1mm REF |
| X | 0.1mm +/-0.1mm |

Packaging Specifications

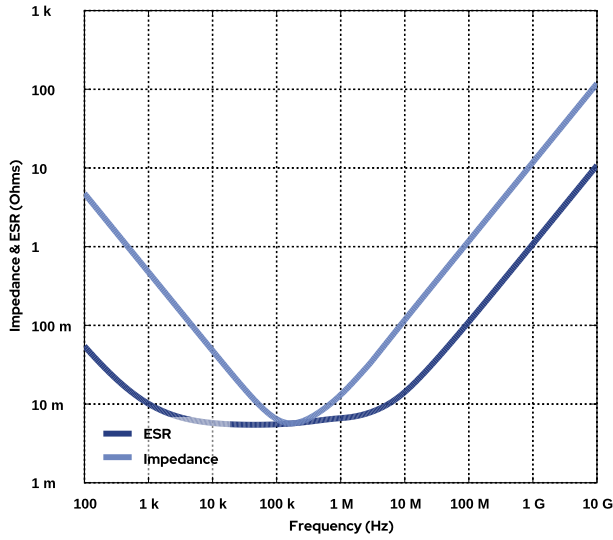
| | |
|--------------------|------------|
| Packaging | T&R, 178mm |
| Packaging Quantity | 500 |

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

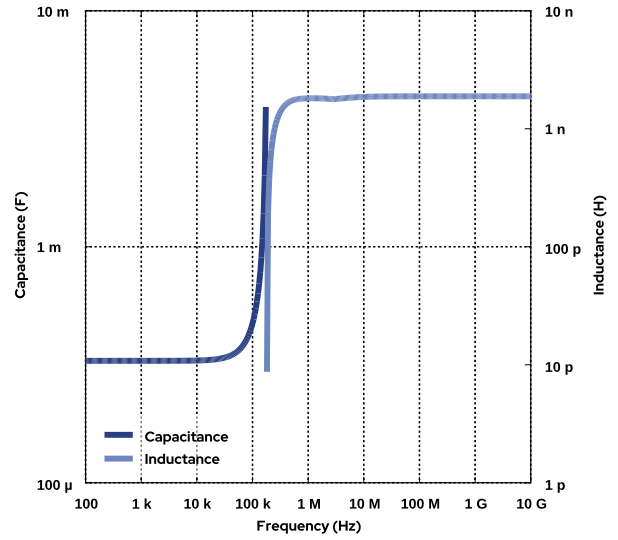
Simulations

For the complete simulation environment please visit [K-SIM](#).

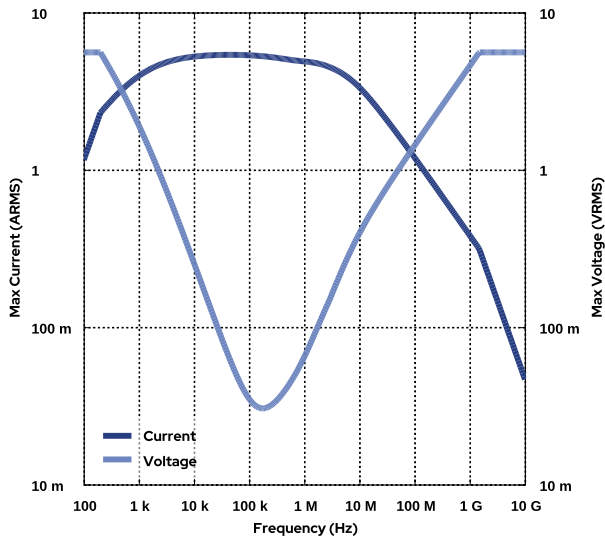
Impedance and ESR



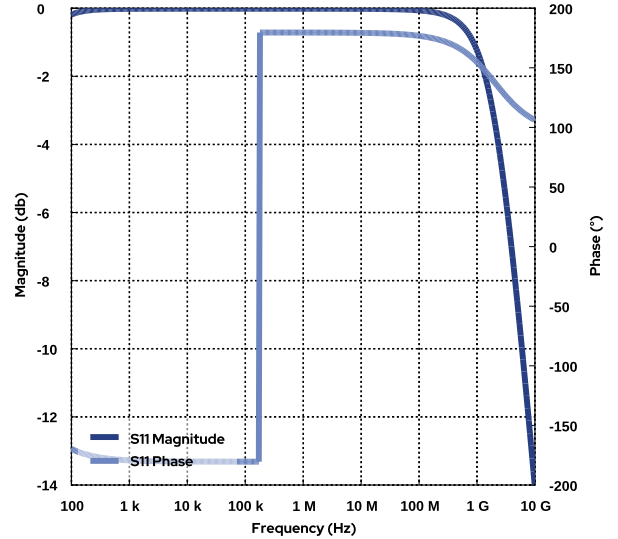
Capacitance and Inductance



Current and Voltage



S11



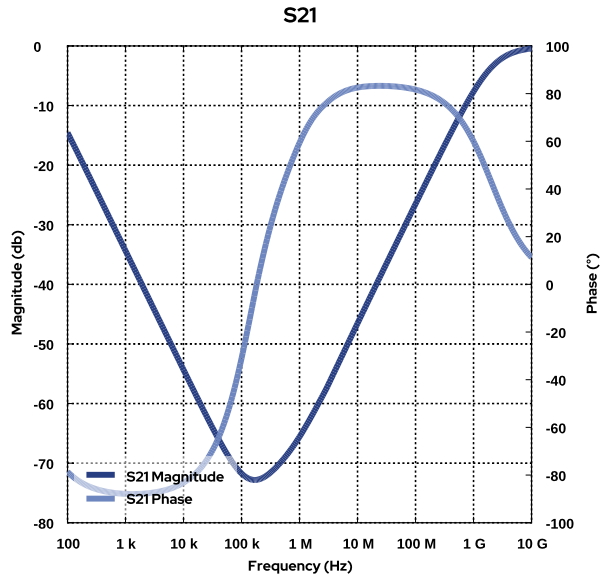


a YAGEO company

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These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.
- The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
- The effects shown herein are based on measured data from a multiple part sample of the parts in question.
- Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance).
- The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages generated at any other harmonics.
- Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

All Information given herein is believed to be accurate and reliable, but is presented without guarantee, warranty, or responsibility of any kind, expressed or implied. Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute – and we specifically disclaim – any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

If you have any questions please contact K-SIM.